SHARP GP1S096HCZ

## GP1S096HCZ

### **■** Features

- 1. Compact package
- 2. Low profile (Height: 2.9mm)
- 3. Gap width: 1.0mm
- 4. Slit width (detector side):0.3mm

### ■ Applications

- 1. Cameras
- 2. DVD players
- 3. CD-ROM drivers
- 4. Floppy disk drivers

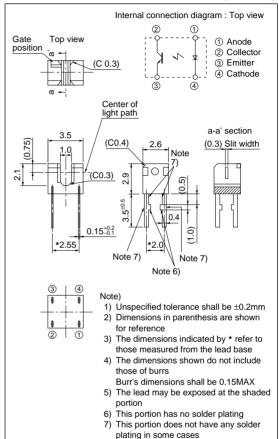
Parameter Symbol Rating Unit					
	Parameter	Symbol	Rating	Unit	
	Forward current	$I_{\mathrm{F}}$	50	mA	
Input	Reverse voltage	$V_R$	6	V	
	Power dissipation	P	75	mW	
Output	Collector-emitter voltage	$V_{CEO}$	35	V	
	Emitter-collector voltage	V <sub>ECO</sub>	6	V	
	Collector current	$I_{C}$	20	mA	
	Collector power dissipation	Pc	75	mW	
	Total power dissipation	P <sub>tot</sub>	100	mW	
Operating temperature		$T_{opr}$	-25 to +85	°C	
	Storage temperature	T <sub>stg</sub>	-40 to +100	°C	
*1	Soldering temperature	Teol	260	°C	

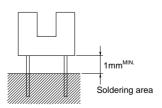
<sup>\*1</sup> For 5s or less

# Subminiature, Transmissive Type Photointerrupter

### ■ Outline Dimensions

(Unit: mm)





■ Electro-optical Characteristics
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■ Electro-optical Characteristics									
Parameter Symbol			Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
Input	Forward voltage		$V_{F}$	I <sub>F</sub> =20mA	_	1.2	1.4	V	
	Reverse cur	rent	$I_R$	$V_R=3V$	_	_	10	μA	
Output	Collector dark current		$I_{CEO}$	V <sub>CE</sub> =20V	_	_	100	nA	
Transfer charac- teristics	Collector current		$I_{C}$	V <sub>CE</sub> =5V, I <sub>F</sub> =5mA	100	-	400	μΑ	
	Response time	Rise time	$t_r$	$V_{CE}=5V, I_{C}=100\mu A$	-	50	150	μs	
		Fall time	$t_{\rm f}$	$R_L=1~000\Omega$	_	50	150	μs	
	Collector-emitter saturation voltage		V <sub>CE(sat)</sub>	I <sub>F</sub> =10mA, Ic=50μA	_	_	0.4	V	

Fig.1 Forward Current vs. Ambient **Temperature** 

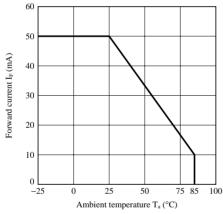


Fig.3 Forward Current vs. Forward Voltage

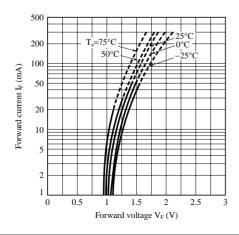


Fig.2 Power Dissipation vs. Ambient **Temperature** 

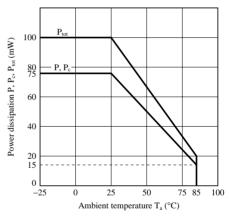
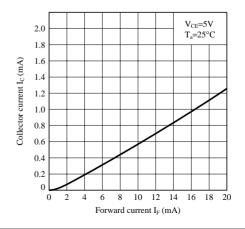


Fig.4 Collector Current vs. Forward Current



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Fig.5 Collector Current vs. Collector-emitter Voltage

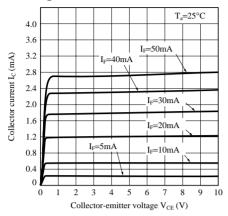


Fig.7 Collector - emitter Saturation Voltage vs. Ambient Temperature

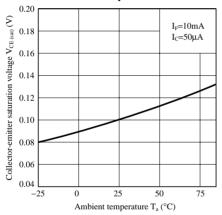


Fig.9 Response Time vs. Load Resistance

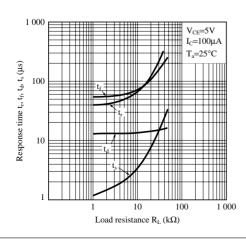


Fig.6 Relative Collector Current vs.
Ambient Temperature

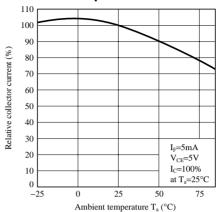


Fig.8 Collector Dark Current vs. Ambient Temperature

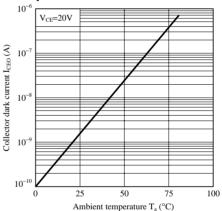
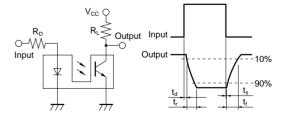


Fig.10 Test Circuit for Response Time



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Fig.11 Detecting Position Characteristics (1) (Typical Value)

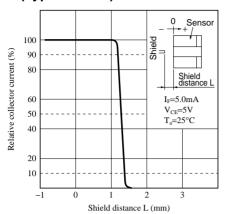
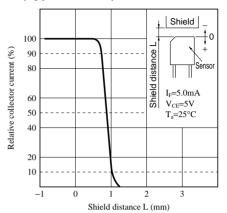


Fig.12 Detecting Position Characteristics (2) (Typical Value)



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